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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.		
09/684,519	10/10/2000	Jin-Yuan Lee	MEG2000-001 3369			
28112	7590 03/31/2003					
GEORGE O.	SAILE & ASSOCIAT	EXAMINER				
	28 DAVIS AVENUE POUGHKEEPSIE, NY 12603			BUI, HUNG S		
			ART UNIT	PAPER NUMBER		
			2841			
			DATE MAILED: 03/31/2003			

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application	No.	Applicant(s)				
	09/684,519		LEE, YIN-YUAN				
Office Action Summary	Examiner		Art Unit				
	Hung S Bui		2841	·			
The MAILING DATE of this communication appears on the cover sheet with the correspond nce address Period f r Reply							
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.  - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.  - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).  - Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).  Status							
1) Responsive to communication(s) filed on	<u> </u>						
2a) This action is <b>FINAL</b> . 2b) ☑ Thi	is action is n	on-final.					
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is							
closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213. <b>Disposition of Claims</b>							
4)⊠ Claim(s) <u>1-72</u> is/are pending in the application.							
4a) Of the above claim(s) is/are withdrawn from consideration.							
5) Claim(s) is/are allowed.							
6)⊠ Claim(s) <u>1-5,18-24,35-39,52-58 and 69-72</u> is/are rejected.							
7) Claim(s) <u>6-17,25-34,40-51 and 59-68</u> is/are ob	jected to.						
8) Claim(s) are subject to restriction and/or election requirement.							
Application Papers	_						
9) The specification is objected to by the Examiner.  10) The drawing(s) filed on is/are: a) □ accepted or b) □ objected to by the Examiner.							
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  11) The proposed drawing correction filed on is: a) approved b) disapproved by the Examiner.							
If approved, corrected drawings are required in reply to this Office action.							
12) The oath or declaration is objected to by the Examiner.							
Priority under 35 U.S.C. §§ 119 and 120							
13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).							
a) ☐ All b) ☐ Some * c) ☐ None of:							
1. Certified copies of the priority documents have been received.							
2. Certified copies of the priority documents have been received in Application No							
Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.							
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).							
a) ☐ The translation of the foreign language provisional application has been received.  15) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.							
Attachment(s)							
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s)	5		(PTO-413) Paper No( atent Application (PT				

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## **DETAILED ACTION**

## Claim Rejections - 35 USC § 112

1. The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

- 2. Claims 52-56 and 71-72 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.
- Claim 52 lacks sufficient structure for the functional limitation of "treating one or more ...by method of etching or swelling..."
- Claim 53 lacks sufficient structure for the functional limitation of " curing one or more of the created layers."
- Claim 54 lacks sufficient structure for the functional limitation of "thermal curing."
- Claim 55 lacks sufficient structure for the functional limitation of "e-beam curing."
  - Claim 56 lacks sufficient structure for the functional limitation of "uv-curing."
- Claim 71 lacks sufficient structure for the functional limitation of the "layers of thermal stress relieve ..... uses a laminating process."
- Claim 72 lacks sufficient structure for the functional limitation of " layers of thermal stress .... using a liquid depositing process."

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## Claim Rejections - 35 USC § 103

3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

- (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 1-5, 18-24, 35-39, 52-58, 69-72 are rejected under 35 U.S.C. 103(a) as being unpatentable over Anderson et al. [US 5,969,461] in view of Lin et al. [US 5,450,283].

Regarding claims 35-38, 52-56 and 71-72, Anderson et al. discloses a printed circuit board structure (figure 1) comprising:

- a circuit board substrate (16) on the surface of which at least one point of an electrical contact (18) has been provided;
- one or more layers of underfill material (28) applied to the surface of the printed circuit board;
- a device (10) having a plurality of solder balls (20) mounted thereon; and
- wherein electrical contact is made between the point of electrical contact
  on the surface of the printed circuit board and at least one of the solder
  balls.

Anderson et al. disclose the instant claimed invention except for the specific material used for the underfill material and the device being a semiconductor device.

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Lin et al. disclose a semiconductor flip chip (18) mounted on a printed circuit board (12) via aplurality of solder balls (64) with an underfill layer (28) formed of a thermal stress reducing compliant material.

It would have been obvious to a person having ordinary skill in the art at the time invention was made to use the thermal stress reducing compliant material of Lin et al. for the underfill material of Anderson et al., for the purpose of reducing stress between the chip and the circuit board.

Regarding claims 39 and 57-58, Anderson et al. disclose the instant claimed invention except for the multiple layer printed circuit board structure and resin filler overlying points of electrical contact.

Lin et al. disclose a multiple layer printed circuit board structure and resin filler overlying points of electrical contact (14) mounted on an upper surface of the printed circuit board with interconnecting vias (figure 9).

It would have been obvious to a person having ordinary skill in the art at the time invention was made to use the multi layer circuit board/contact design of Lin et al. for the printed circuit board of Anderson et al., for the purpose of providing multiple signal paths and facilitating mounting of the semiconductor chip.

Regarding claims 1-5, 18-24 and 69-70, as acknowledged by applicant (see response to restriction), the claimed method steps would have been inherent in the product structure.

Allowable Subj ct Matt r

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Claims 6-17, 25-34, 40-51 and 59-68 are objected to as being dependent upon a 5.

rejected base claim, but would be allowable if rewritten in independent form including all

of the limitations of the base claim and any intervening claims.

Response to Arguments

Applicant's arguments with respect to claims 1-72 have been considered but are 6.

moot in view of the new ground(s) of rejection.

Conclusion

7. Any inquiry concerning this communication or earlier communications from the

examiner should be directed to Hung S Bui whose telephone number is (703) 305-8024.

The examiner can normally be reached on Monday-Friday 8:30AM-6:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, David S. Martin can be reached on (703) 308-3121. The fax phone

numbers for the organization where this application or proceeding is assigned are (703)

308-7722 for regular communications and (703) 308-7724 for After Final

communications.

Any inquiry of a general nature or relating to the status of this application or

proceeding should be directed to the receptionist whose telephone number is (703) 305-

0956.

DAVID MARTIN

SUPERVISORY PATENT EXAMINER TECHNOLOGY CENTER 2800

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